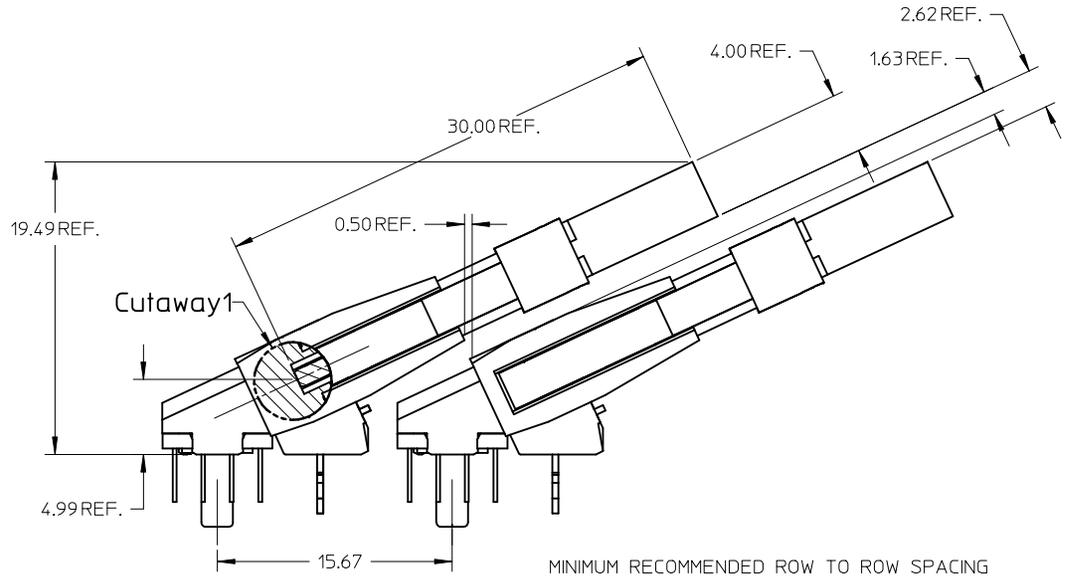


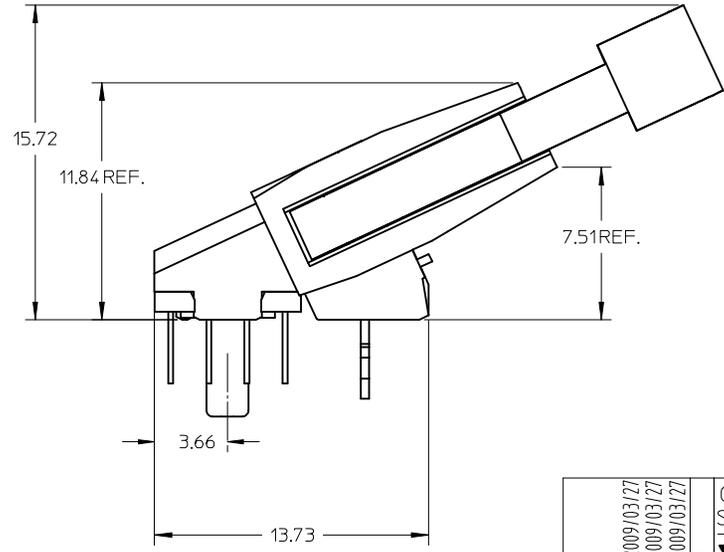
NOTES:

- MATERIALS : HOUSING AND BASEPLATE
  - LCP, GLASS FILLED, UL 94V-0, BLACK LATCH
  - HIGH TEMP. NYLON, GLASS FILLED, UL 94-0, NATURAL (OFF WHITE)
  - TERMINALS AND FORKLICK - COPPER ALLOY
- PLATING : CONTACT AREA - SEE TABLE IN SHEET 5  
SOLDERTAIL - SEE TABLE IN SHEET 5
- REFER TO PRODUCT SPECIFICATION, PS-87803-003 FOR PERFORMANCE SPECIFICATIONS.
- CARD SLOTS ACCEPTS 1.27±0.10 MM MODULE THICKNESS. (MEASURED OVER PC PADS)
- RECOMMENDED MODULE CARD LAYOUT SHALL BE AS PER JEDEC MO-237.
- PRODUCT IS PACKED IN TRAY.
- MOLEX LOGO, DATE CODE AND PART NUMBER INDICATED ON HOUSING.
- CONTACT MOLEX FOR AVAILABILITY OF PRODUCT OPTIONS.

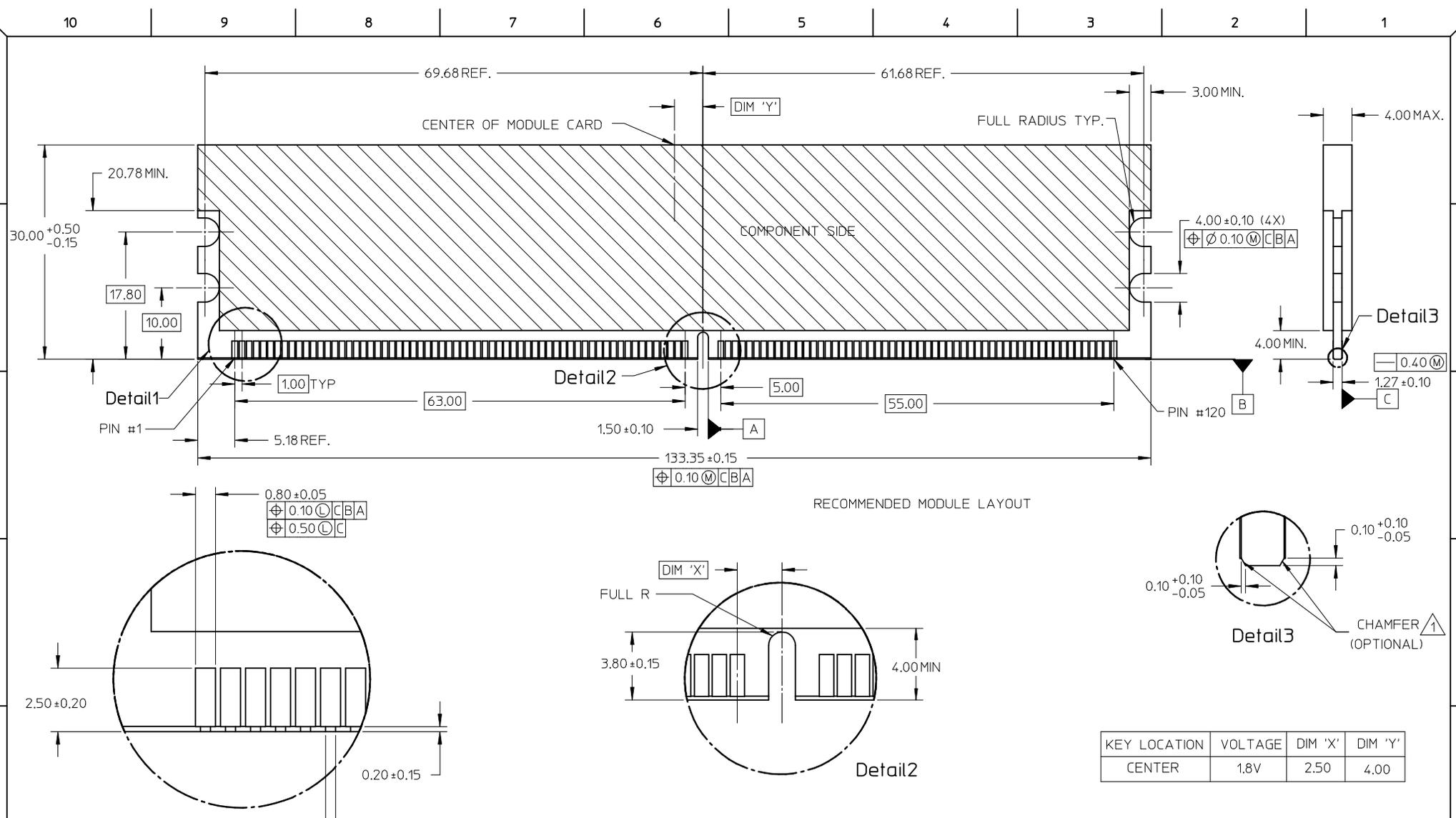
ADDED OPTION EC NO: S2009-0629 DRW: CCTEH CHKD: CGTAN APPR: SILENI	2009/03/27 2009/03/27 2009/03/27	DESCRIPTION B1	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION																		
			$\nabla=0$ $\square=0$	<table border="1"> <tr> <th></th> <th>mm</th> <th>INCH</th> </tr> <tr> <td>4 PLACES</td> <td>± ---</td> <td>± ---</td> </tr> <tr> <td>3 PLACES</td> <td>± ---</td> <td>± ---</td> </tr> <tr> <td>2 PLACES</td> <td>± 0.25</td> <td>± ---</td> </tr> <tr> <td>1 PLACE</td> <td>± ---</td> <td>± ---</td> </tr> </table>		mm	INCH	4 PLACES	± ---	± ---	3 PLACES	± ---	± ---	2 PLACES	± 0.25	± ---	1 PLACE	± ---	± ---	MM ONLY	NTS	METRIC	TITLE DDR2 DIMM, 1.00MM PITCH 240 CKTS, 25 DEG.			
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A3																										



MINIMUM RECOMMENDED ROW TO ROW SPACING  
WHEN USING A 4.00MM THICK  
MODULE (TYPICAL TSOP PACKAGING)



ADDED OPTION EC NO: S2009-0629 DRWN: CCTEH 2009/03/27 CH'KD: GGTAN 2009/03/27 APPR: SHLENI 2009/03/27	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY	DATE	TITLE			
		4 PLACES	± ---	± ---	MLONG	2004/03/25	DDR2 DIMM, 1.00MM PITCH			
		3 PLACES	± ---	± ---	CHECKED BY	DATE	240 CKTS, 25 DEG.			
	2 PLACES	± 0.25	± ---	SRRAMESH	2004/03/26	MOLEX INCORPORATED				
	1 PLACE	± ---	± ---	APPROVED BY	DATE	DOCUMENT NO.				
	ANGULAR ± 5 °		GGLLEE		2004/03/26	SD-87803-010				
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		SEE TABLE	SHEET NO.				
			SIZE		A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



KEY LOCATION	VOLTAGE	DIM 'X'	DIM 'Y'
CENTER	1.8V	2.50	4.00

NOTES :  
 1 MODULE CARD USED IN PRODUCT TESTING ARE CHAMFERED.

ADDED OPTION  
 EC NO: S2009-0629  
 DRW:NCCTEH  
 CHKD:CGTAN  
 APPR:SHLENI

REV	DESCRIPTION
B1	

QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm	INCH
▽=0	4 PLACES ±---	±---
◻=0	3 PLACES ±---	±---
	2 PLACES ±0.25	±---
	1 PLACE ±---	±---
	ANGULAR ± 5 °	
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE	
MM ONLY	
DRAWN BY	DATE
MLONG	2004/03/25
CHECKED BY	DATE
SRRAMESH	2004/03/26
APPROVED BY	DATE
GGLEE	2004/03/26
MATERIAL NO.	
SEE TABLE	

SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
NTS	METRIC	☉
TITLE		
DDR2 DIMM, 1.00MM PITCH 240 CKTS, 25 DEG.		
MOLEX INCORPORATED		SHEET NO.
DOCUMENT NO. SD-87803-010		3 OF 5
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		



PART NO.	VOLTAGE KEY	DIM 'P'	DIM 'Q'	RECOMMENDED PCB THICKNESS	CONTACT AREA PLATING	SOLDERTAIL PLATING	LUBRICATION	
87803-0002	1.8V	2.79	3.18	1.57	0.38µM/ 15µ" GOLD OVER 1.27µM/ 50µ" MIN NICKEL	2.54µM/ 100µ" MIN. TIN (MATTE) OVER 1.27µM/ 50µ" MIN NICKEL	NO	
87803-0022							YES	
87803-0012		3.18	4.83	2.36			NO	
87803-0032							YES	
87803-0052		4.00	3.18	NO				
87803-0062				YES				
87803-0102		2.79	3.18	1.57	NO			
87803-0122					YES			
87803-0112		3.18	4.83	2.36	0.76µM/ 30µ" GOLD OVER 1.27µM/ 50µ" MIN NICKEL	NO		
87803-0132						YES		
87803-0152						4.00	3.18	NO
87803-0162								YES

ADDED OPTION EC NO: S2009-0629 DRWN: CCTEH 2009/03/27 CHKD: CGTAN 2009/03/27 APPR: SILENI 2009/03/27 REV	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
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		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SEE TABLE	TITLE: DDR2 DIMM, 1.00MM PITCH 240 CKTS, 25 DEG.		MOLEX INCORPORATED DOCUMENT NO. SD-87803-010	
	B1			SIZE: A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO. 5 OF 5